

## IN THE SPECIFICATION

*Insert the following new paragraphs at page 1, line 4:*

--This application is a continuation-in-part of and claims the benefit of priority under 35 USC 119/120 to the following:

*Application Serial No. 09/919,788 filed July 31, 2001 entitled Plating Method and Apparatus that Creates A Differential Between Additive Disposed on a Top Surface and a Cavity Surface of a Workpiece Using an Indirect External Influence, which is a continuation-in-part of:*

*Application Serial No. 09/740,701 filed December 18, 2000 entitled Plating Method and Apparatus that Creates A Differential Between Additive Disposed on a Top Surface and a Cavity Surface of a Workpiece Using an External Influence, now US Patent No. 6,534,116, all of which claim the benefit of priority to Provisional Application Serial No. 60/224,739 filed August 10, 2000 entitled Masked Pulse Plating Method and Apparatus. ---*